



**FEATURES:**

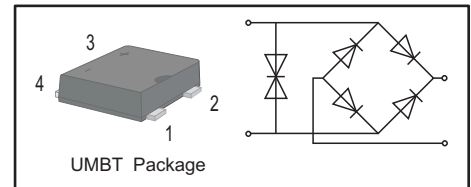
- Lower clamping voltage
- Green Molding Compound  
(No Halogen and Antimony)
- Glass Passivated Chip Junction
- High Surge Current Capability
- Designed for Surface Mount Application

**MECHANICAL DATA**

- Case: UMBT
- Terminals: Solderable per  
MIL-STD-750, Method 2026
- Approx. Weight: 60mg/0.0021oz

**PINNING**

PIN	DESCRIPTION
1	Input Pin (~)
2	Input Pin (~)
3	Output Anode (+)
4	Output Cathode (-)



**Maximum Ratings and Electrical characteristics**

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbols	BP43CUM10B-10	Units
Average Rectified Output Current	$I_O$	1.0	A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	$I_{FSM}$	30	A
Maximum Forward Voltage at 1.0 A	$V_F$	1.1	V
Maximum DC Reverse Current at Rated DC Blocking Voltage (@ $V_R=1000V$ )	$I_R$	5 40	$\mu A$
Typical Junction Capacitance (Note1)	$C_j$	7	pF
Typical Thermal Resistance (Note2)	$R_{\theta JA}$ $R_{\theta JC}$ $R_{\theta JL}$	45 15 25	$^{\circ}C/W$
Operating and Storage Temperature Range	$T_j, T_{stg}$	-55 ~ +150	$^{\circ}C$

Note: 1. Measured at 1MHz and applied reverse voltage of 4 V D.C.

2. Mounted on glass epoxy PC board with 4×1.5"×1.5" (3.81×3.81 cm) copper pad.

**Maximum Ratings and Thermal Characteristics(TA = 25°C unless otherwise specified)**

Parameter of TVS	Symbol	BP43CUM10B-10	Unit
Maximum allowable continuous AC voltage at 50-60Hz	$V_{RMS}$	26	V
Breakdown voltage	$V_{BR}$	40.9~45.2	V
Maximum allowable continuous DC voltage	$V_{DC}$	36.8	V
Maximum allowable clamping voltage	$V_C$	59.3	V
Maximum peak pulse current	$I_{pp}$	11.2	A
Operating and Storage Temperature Range	$T_j, T_{stg}$	-55 ~ +150	$^{\circ}C$

**NOTES:**

1. The breakdown voltage was measured at 1mA
2. The clamping voltage was measured at 10/1000 $\mu s$  standard current
3. The peak pulse current was tested at 10/1000 $\mu s$  waveform



Fig.1 Average Rectified Output Current Derating Curve

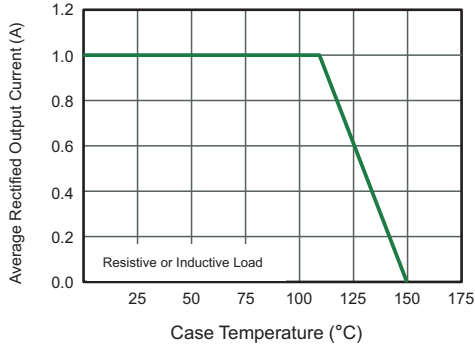


Fig.2 Typical Reverse Characteristics

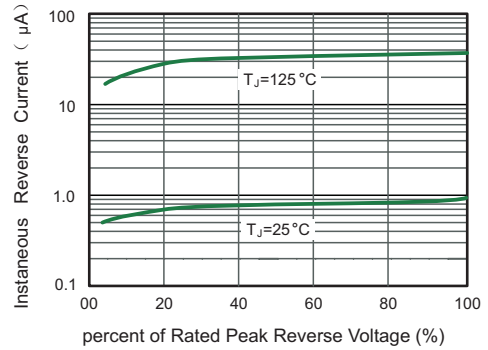


Fig.3 Typical Forward Characteristic

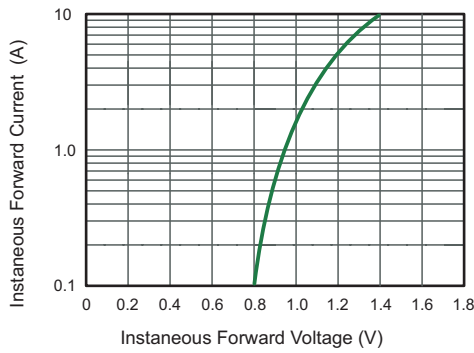


Fig.4 Typical Junction Capacitance

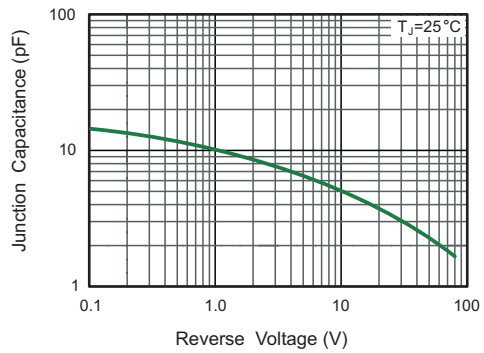


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

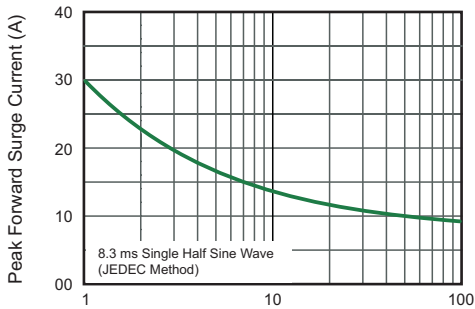


Fig.6 Peak Pulse Power Rating Curve

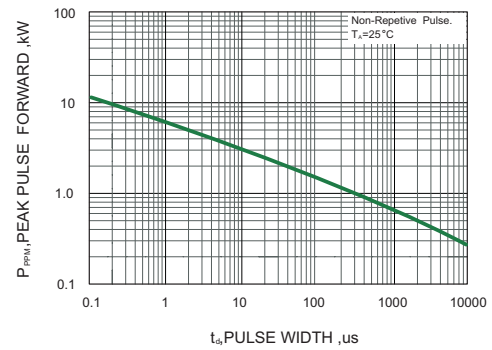


Fig.7 Forward Current Derating Curve

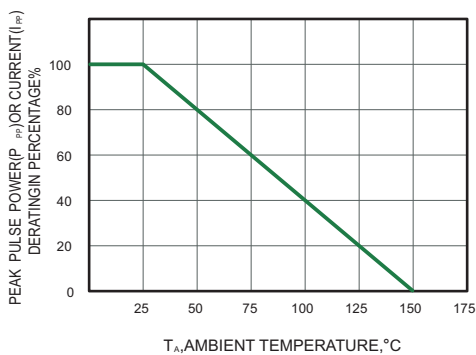
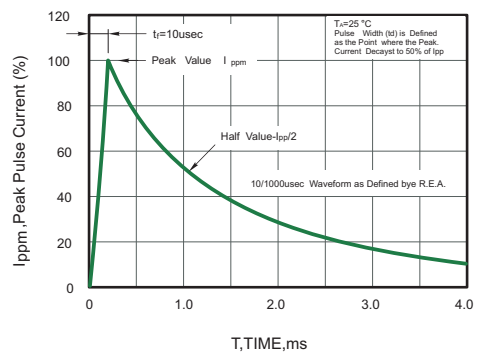


Fig.8 Pulse Waveform

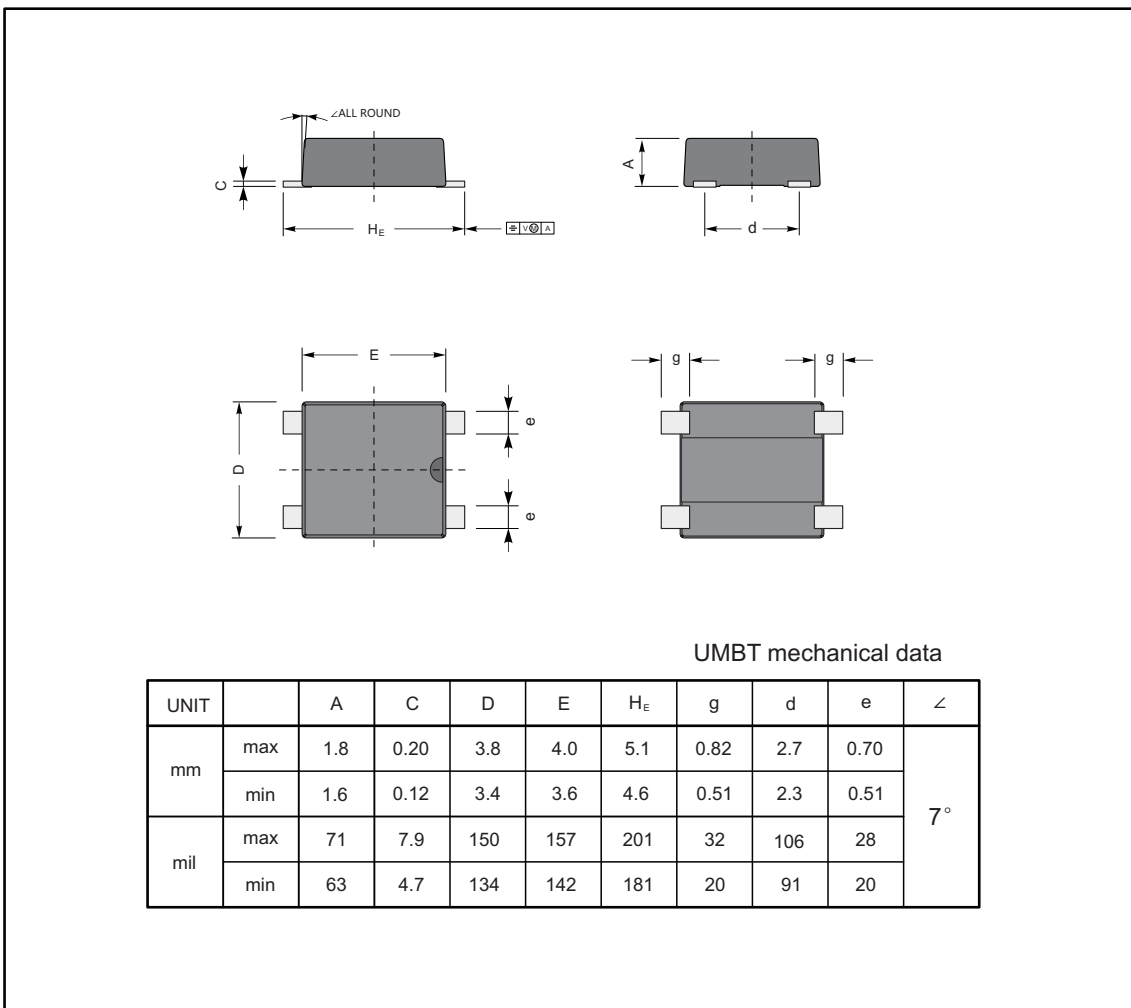




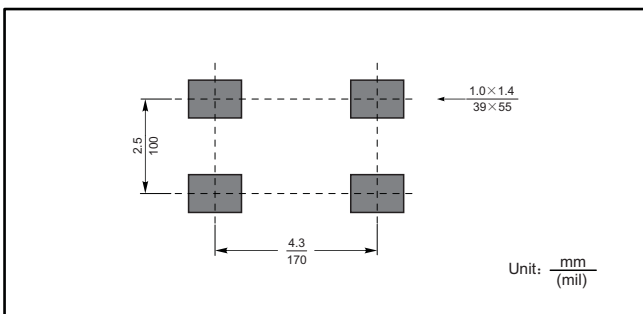
PACKAGE OUTLINE

Plastic surface mounted package; 4 leads

UMBT



The recommended mounting pad size



Marking

Type number	Marking code
BP43CUM10B-10	BP43C10



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